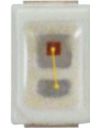


### Mini DomiLED

Synonymous with function and performance, the Mini DomiLED series is perfectly suited for a variety of cross-industrial applications due to its small package outline, durability and superior brightness.



### Features:

- > High brightness surface mount LED.
- > 120° viewing angle.
- > Small package outline (LxWxH) of 2.0 x 1.4 x 1.3mm.
- > Qualified according to JEDEC moisture sensitivity Level 2.
- > Compatible to IR reflow soldering.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q102.



### Applications:

- > Automotive: interior applications, eg: switches, climate control system, dashboard, etc.



### Optical Characteristics at Tj=25°C

Part Ordering Number	Color	Viewing Angle°	Luminous Intensity @ IF = 20mA IV (mcd) <i>Appx. 1.1</i>		
			Min.	Typ.	Max.
DLS-GJS-U5V6-1	Super red, 632nm	120	450.0	715.0	970.0
DLA-GJS-V6W6-2	Amber, 615nm	120	820.0	1300.0	1500.0
DLA-GJS-U7V7-4	Amber, 624nm	120	610.0	820.0	1125.0
DLO-GJS-V6W6-1	Orange, 605nm	120	820.0	1300.0	1500.0
DLY-GJS-V5W5-1	Yellow, 590nm	120	715.0	1125.0	1300.0

### Electrical Characteristics at Tj=25°C

Part Number	Vf @ If = 20mA <i>Appx. 3.1</i>			Vr @ Ir = 10uA
	Min. (V)	Typ. (V)	Max. (V)	Min. (V)
DLx-GJS	1.8	2.1	2.4	12

### Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	50	mA
Peak pulse current; (Ts = 55°C, tp ≤ 100µs, Duty cycle = 0.03)	210	mA
Reverse voltage <i>Appx. 6.1</i>	12	V
ESD threshold (HBM)	2000	V
LED junction temperature	125	°C
Operating temperature	-40 ... +105	°C
Storage temperature	-40 ... +105	°C
Power dissipation (at room temperature)	120	mW
Thermal resistance (Rated current = 20mA, Ts = 25 °C) - Junction / solder point, Rth JS (Mounting on FR4 PCB, pad size >= 16 mm <sup>2</sup> per pad)	175	K/W

**Wavelength Grouping at Tj=25°C**

Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
DLS; Super-red	Full	627 - 637
DLA; Amber	Full	612 - 627
	W	612 - 616
	X	616 - 620
	Y	620 - 624
	Z	624 - 627
DLO; Orange	Full	600 - 609
	W	600 - 603
	X	603 - 606
	Y	606 - 609
DLY; Yellow	Full	586 - 595
	X	586 - 589
	Y	589 - 592
	Z	592 - 595

**Luminous Intensity Group at Tj=25°C**

Brightness Group	Luminous Intensity <i>Appx. 1.1</i> IV (mcd)
U5	450.0 ... 520.0
U6	520.0 ... 610.0
U7	610.0 ... 715.0
V5	715.0 ... 820.0
V6	820.0 ... 970.0
V7	970.0 ... 1125.0
W5	1125.0 ... 1300.0
W6	1300.0 ... 1500.0

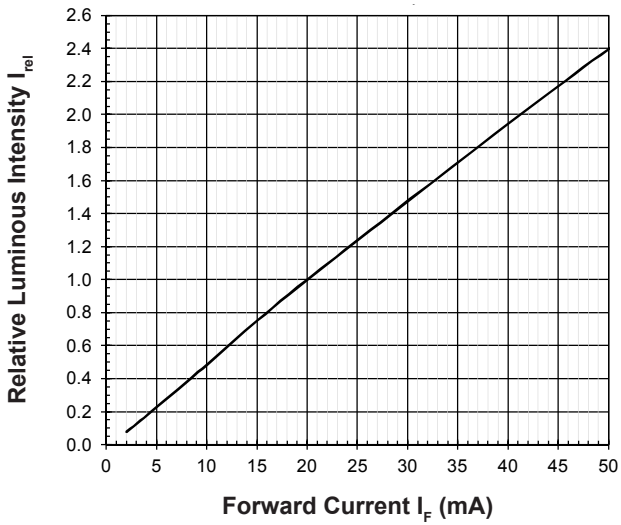
**Vf Binning (Optional)**

Vf @ If = 20mA	Forward Voltage (V) <i>Appx. 3.1</i>
V03	1.80 ... 1.95
V04	1.95 ... 2.10
V05	2.10 ... 2.25
V06	2.25 ... 2.40

Please consult sales and marketing for special part number to incorporate Vf binning.

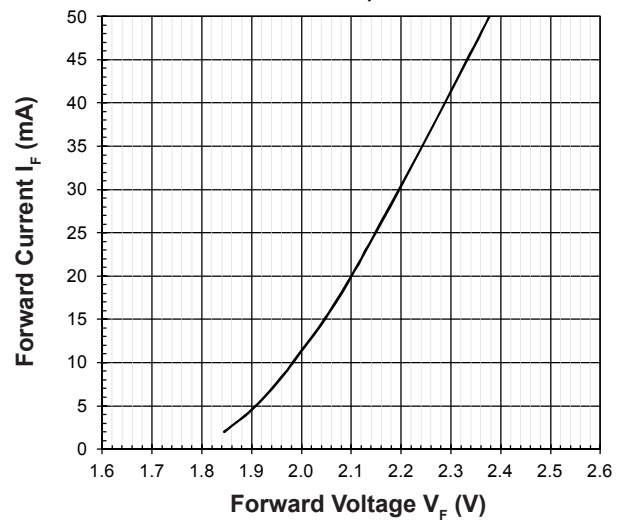
**Relative Luminous Intensity Vs Forward Current**

$I_v/I_v(20\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$



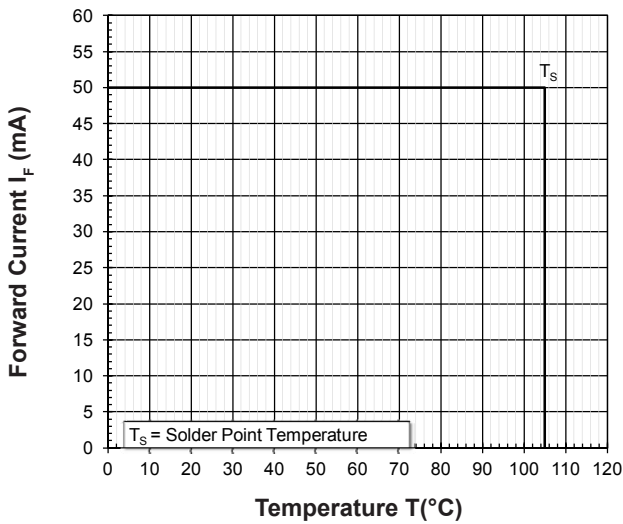
**Forward Current Vs Forward Voltage**

$I_F = f(V_F); T_j = 25^\circ\text{C}$



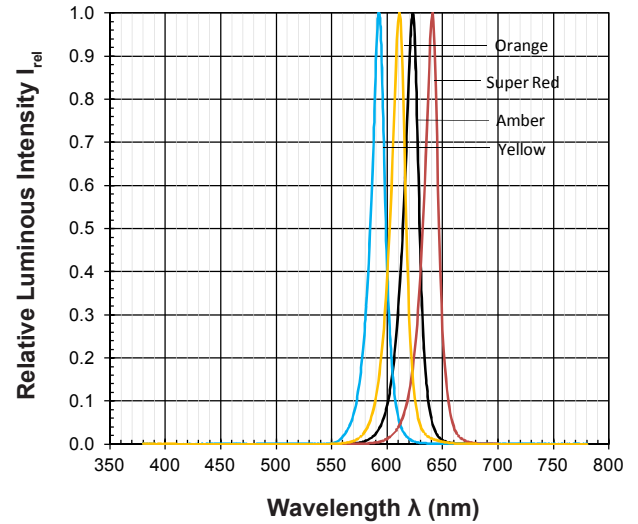
**Maximum Current Vs Temperature**

$I_F = f(T)$



**Relative Spectral Emission**

$I_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 20\text{mA}$

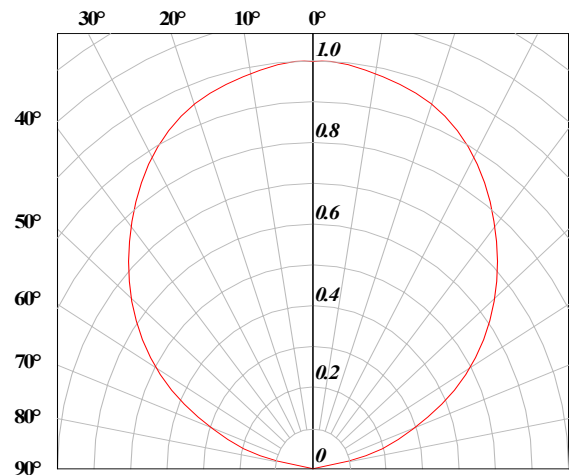


**Allowable Forward Current Vs Duty Ratio**

$(T_s = 55^\circ\text{C}; t_p \leq 100\mu\text{s})$

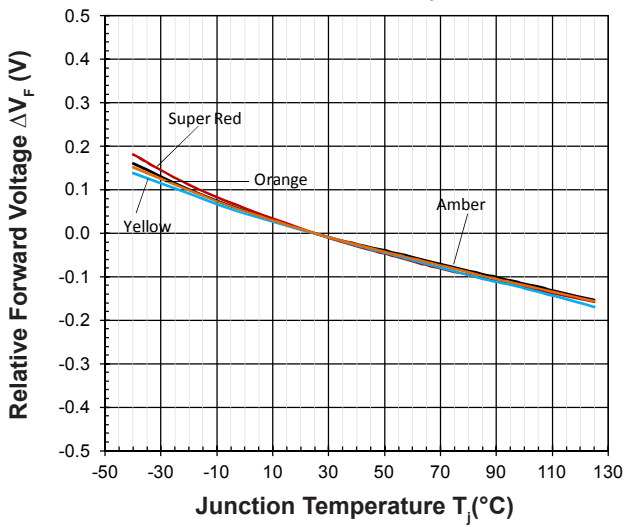


**Radiation Pattern**



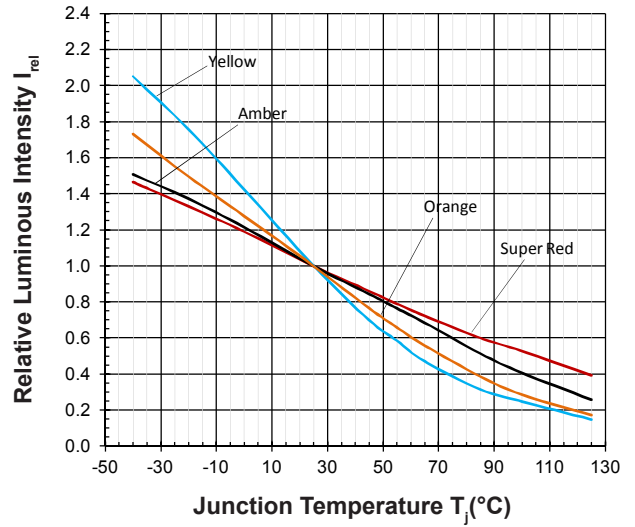
**Relative Forward Voltage Vs Junction Temperature**

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$



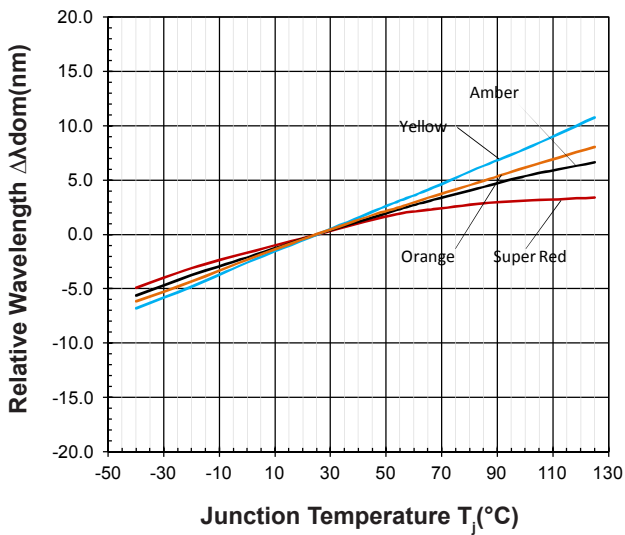
**Relative Luminous Intensity Vs Junction Temperature**

$$I_V/I_V(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$

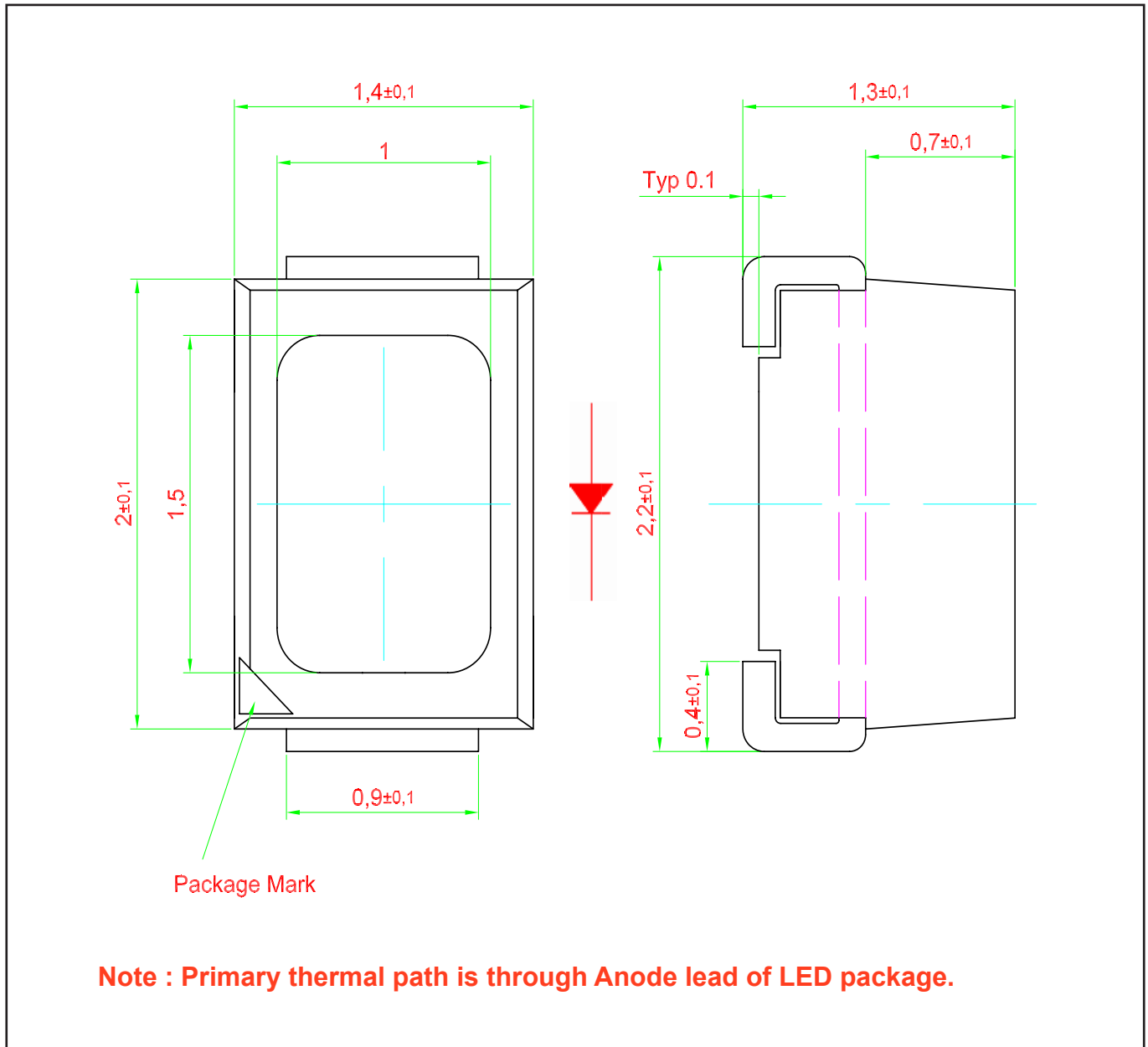


**Relative Wavelength Vs Junction Temperature**

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25^\circ\text{C}) = f(T_j); I_F = 20\text{mA}$$



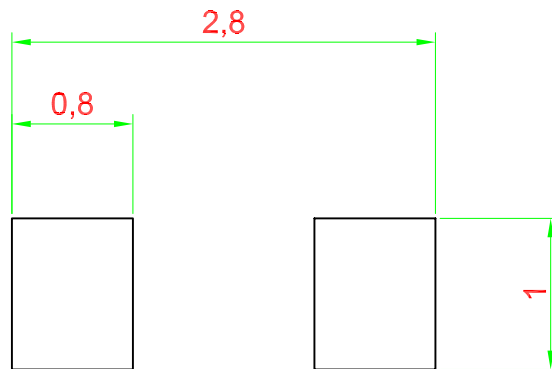
**Mini DomiLED • AllnGaP : DLx-GJS Package Outlines**



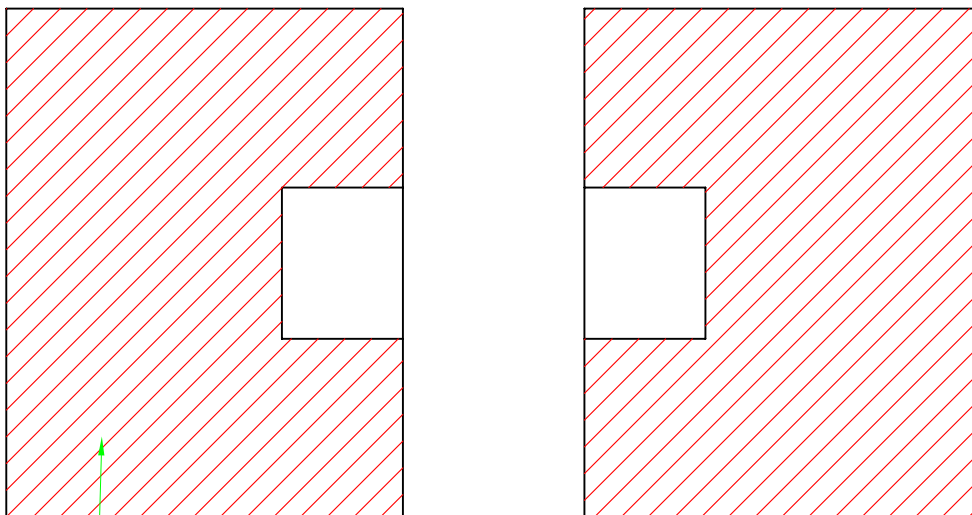
**Material**

Material	
Lead-frame	Cu Alloy With Ag Plating
Package	High Temperature Resistant Plastic, PPA
Encapsulant	Epoxy
Soldering Leads	Sn-Sn Plating

### Recommended Solder Pad



### Improved Design For Better Heat Dissipation

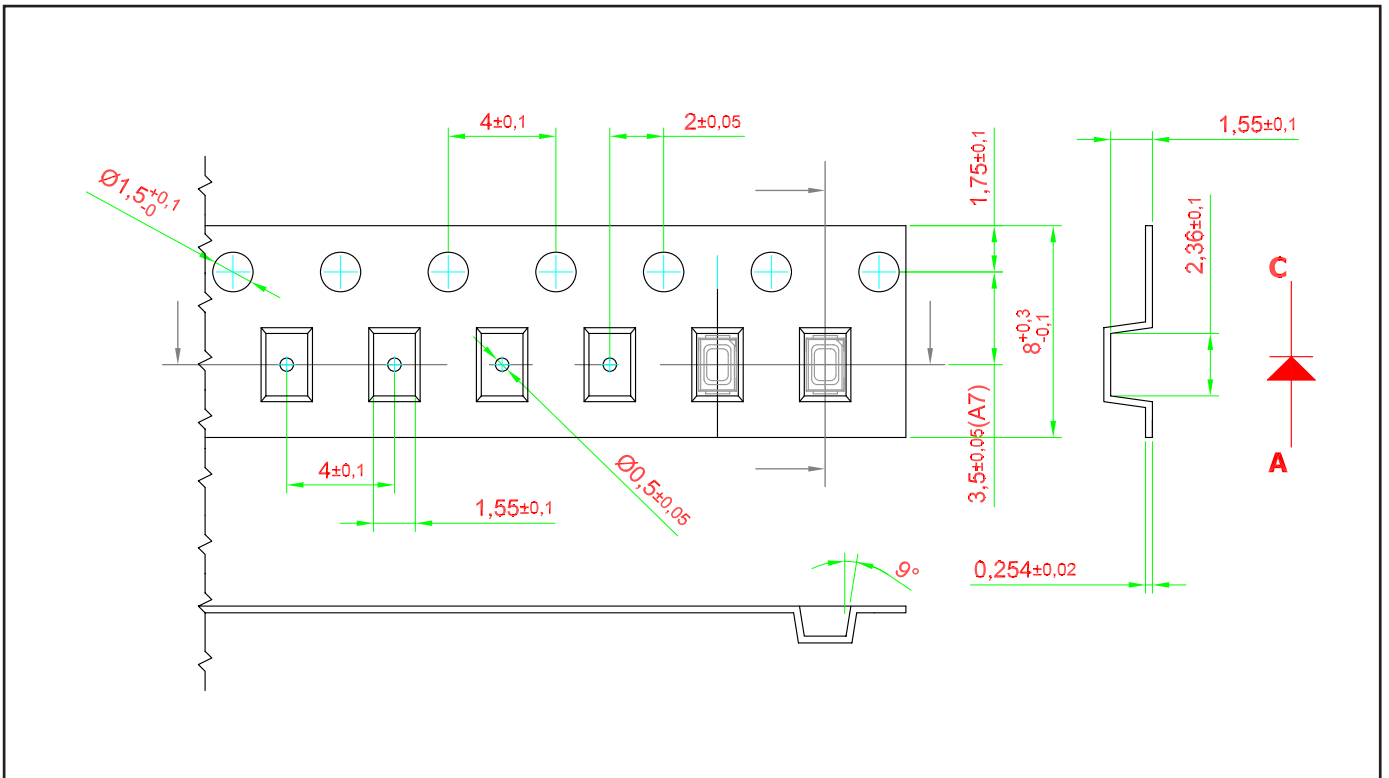


Additional Cu area for improved heat dissipation, > 16mm sq.

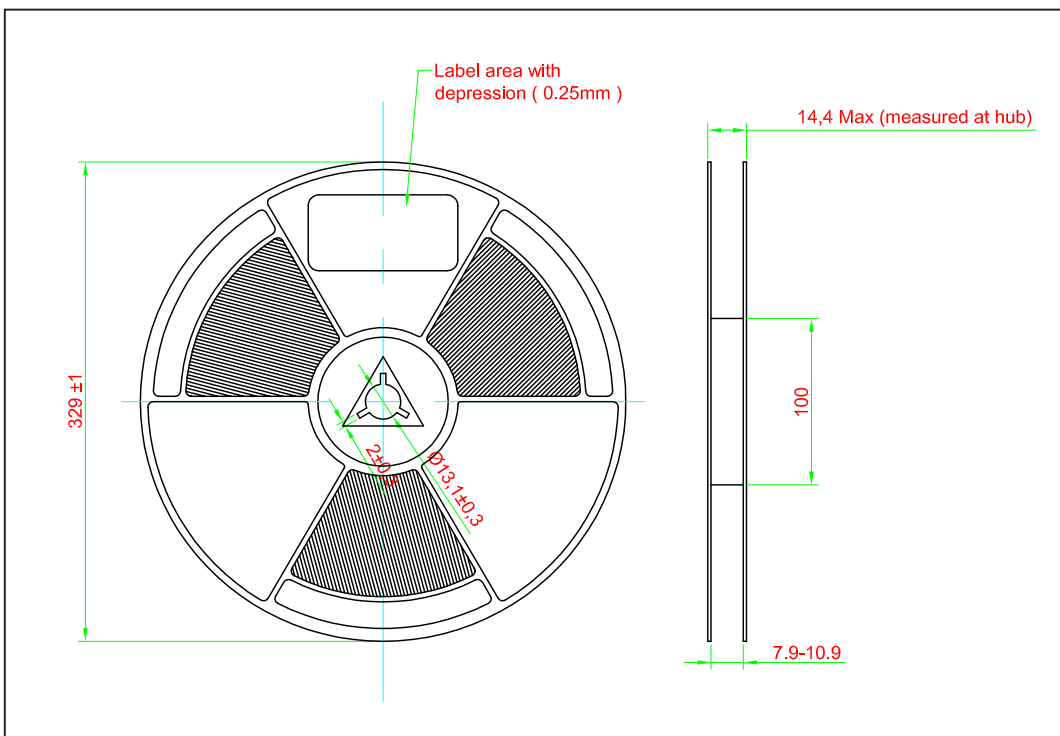
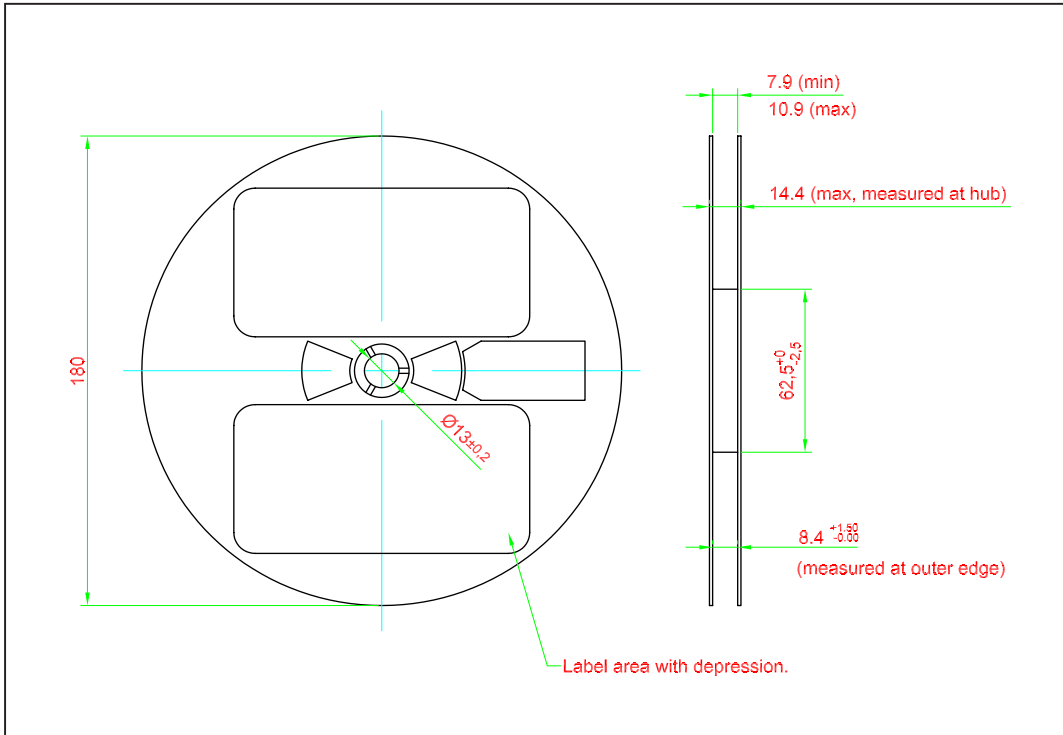
 Solder resist.



### Taping and orientation

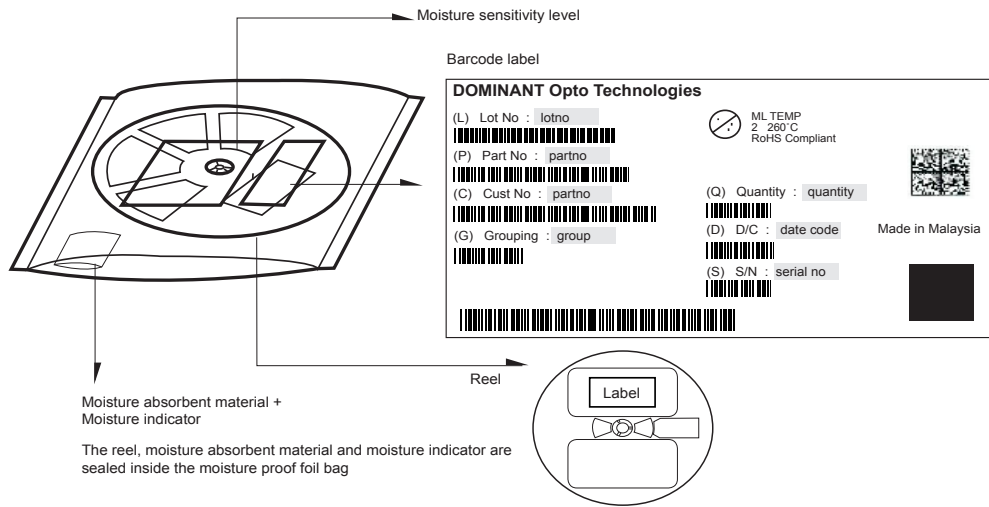


**Packaging Specification**

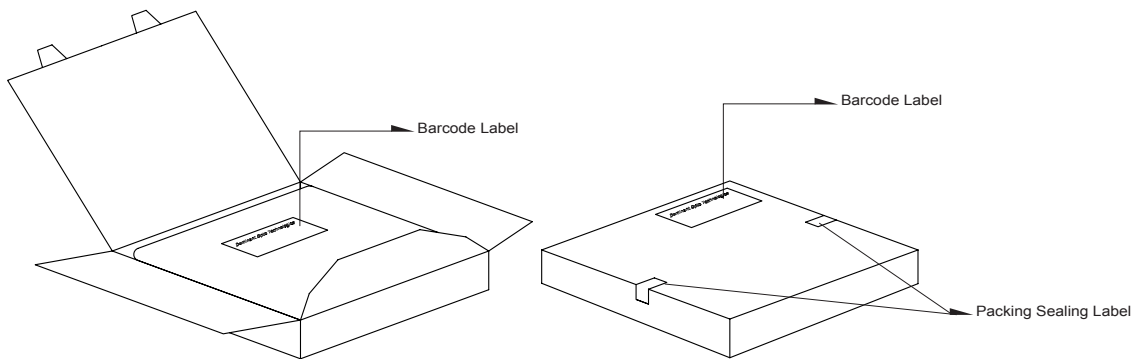


	Reel Diameter (mm)	Quantity (pcs)	Partno
Standard Packing	180	3000	DLx-GJS-xxx-x
Optional Packing	329	10000	DLx-GJS-xxx-x-J

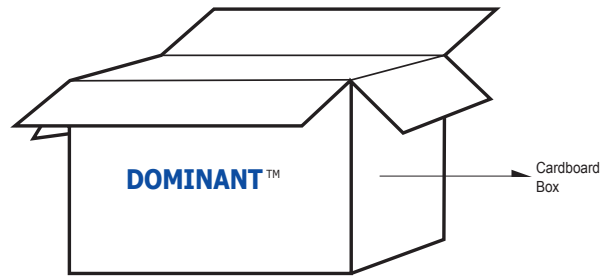
**Packaging Specification**



Quantity per bag (pcs)	Average 1pc Mini DomiLED (gram)	1 completed bag (gram)
3000	0.007	200 ± 10
10000	0.007	550 ± 10



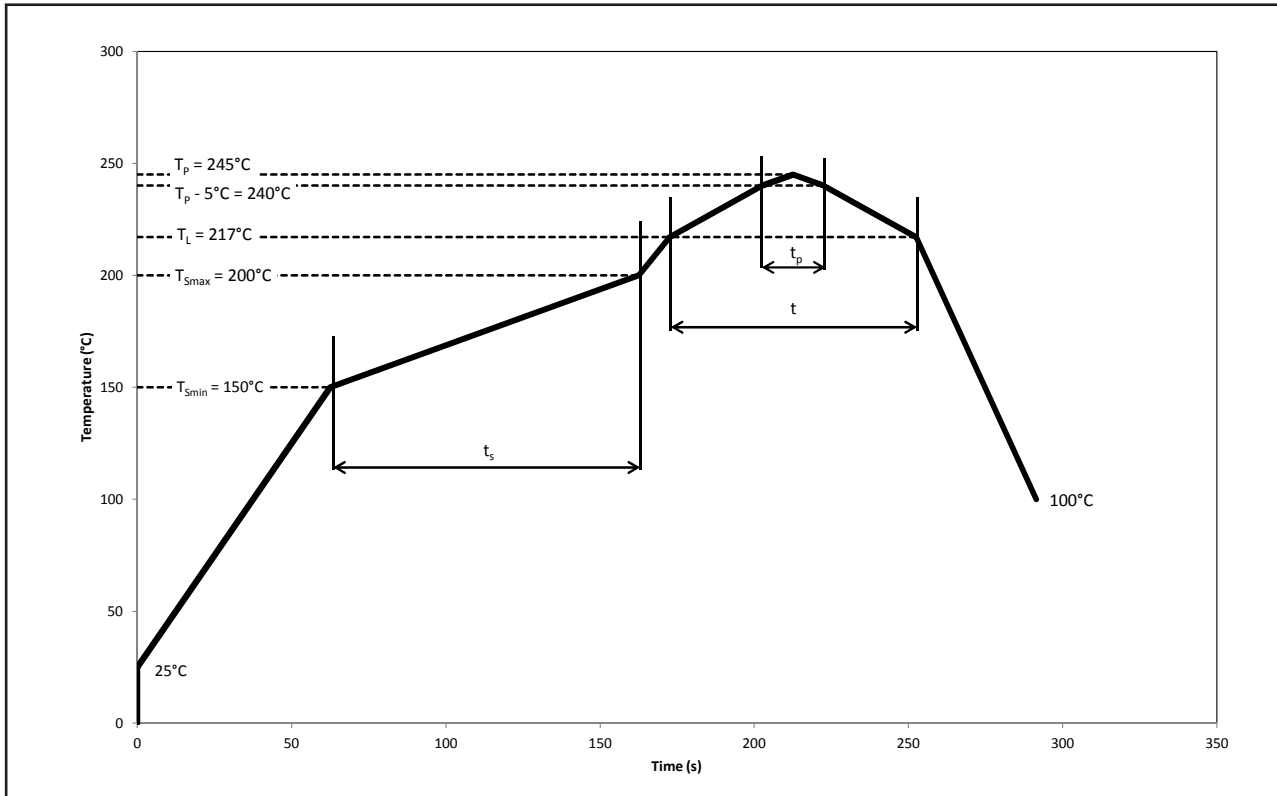
Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 16
329	345 x 345 x 16



Reel Diameter (mm)	Cardboard Box Size	Dimensions (mm)	Empty Box Weight (kg)	Reel / Box
180	Super Small	325 x 225 x 190	0.38	9 reels MAX
180	Small	325 x 225 x 280	0.54	15 reels MAX
180	Medium	570 x 440 x 230	1.46	60 reels MAX
180	Large	570 x 440 x 460	1.92	120 reels MAX
329	Medium	373 x 373 x 285	1.02	13 reels MAX
329	Large	580 x 373 x 405	1.50	30 reels MAX

**Recommended Pb-free Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-20E



Profile Feature	Symbol	Pb-Free Assembly			Unit
		Min.	Recommended	Max.	
Ramp-up rate to preheat 25°C to $T_{smin}$	-	-	2	3	°C/s
Time $t_s$ $T_{smin}$ to $T_{smax}$	$t_s$	60	100	120	s
Ramp-up rate to peak $T_L$ to $T_p$	-	-	2	3	°C/s
Liquidous temperature	$T_L$	-	217	-	°C
Time above liquidous temperature	t	60	80	150	s
Peak temperature	$T_p$	-	245	260	°C
Time within 5°C of the specified peak temperature $T_p - 5°C$	$T_p$	10	20	30	s
Ramp-down rate $T_p$ to 100°C	-	-	3	6	°C/s
Time 25°C to $T_p$	-	-	-	480	s

## Appendix

### 1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (according to GUM with a coverage factor of  $k=3$ ).

### 2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (accordingly to GUM with a coverage factor of  $k=3$ ).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of  $\pm 0.5\text{nm}$  and an expanded uncertainty of  $\pm 1\text{nm}$  (accordingly to GUM with a coverage factor of  $k=3$ ).

### 3) **Voltage:**

- 3.1 Forward Voltage,  $V_f$  is measured when a current pulse of 8 ms(typ) with an internal reproducibility of  $\pm 0.05\text{V}$  and an expanded uncertainty of  $\pm 0.1\text{V}$  (accordingly to GUM with a coverage factor of  $k=3$ ).

### 4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

### 5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimension are specific in mm.

### 6) **Reverse Voltage:**

- 6.1 Not designed for reverse operation. Continuous reverse voltage can cause migration and LED damage.

**Revision History**

Page	Subjects	Date of Modification
-	Initial Release	06 Jan 2021

**NOTE**

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## About Us

DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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